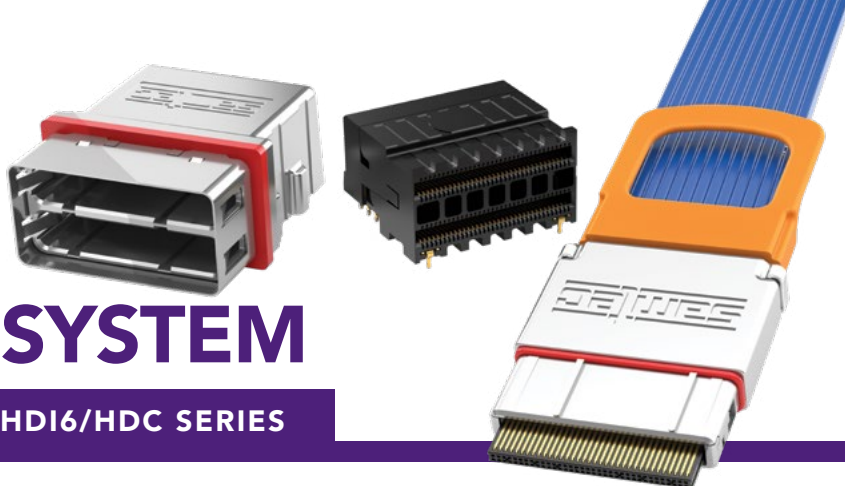


HIGH-DENSITY HIGH-SPEED I/O SYSTEM

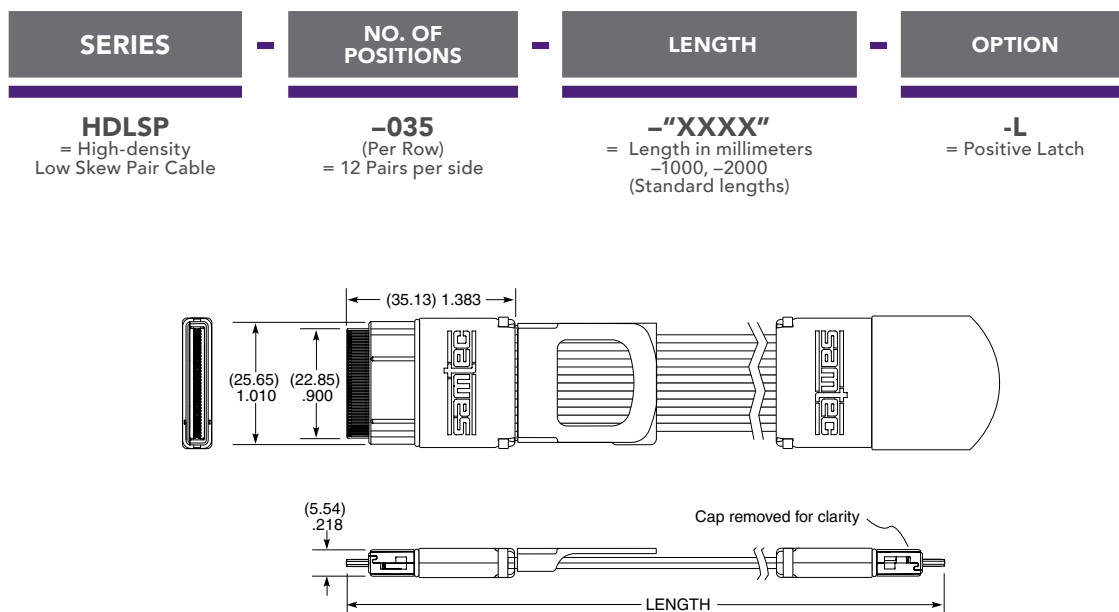
(0.635 mm) .025" PITCH • HDLSP/HDI6/HDC SERIES



HDLSP Mates: HDI6

SPECIFICATIONS

Cable:
32 AWG low skew
pair cable
Insulator Material:
LCP
Terminal Material:
Phosphor Bronze
Jacket Material:
PVC
Insulator:
Dielectric
Conductors:
Copper
Braid:
Tinned Copper
Covers:
Diecast Zinc Alloy
Current Rating:
1.5 A per pin
(4 adjacent pins powered)



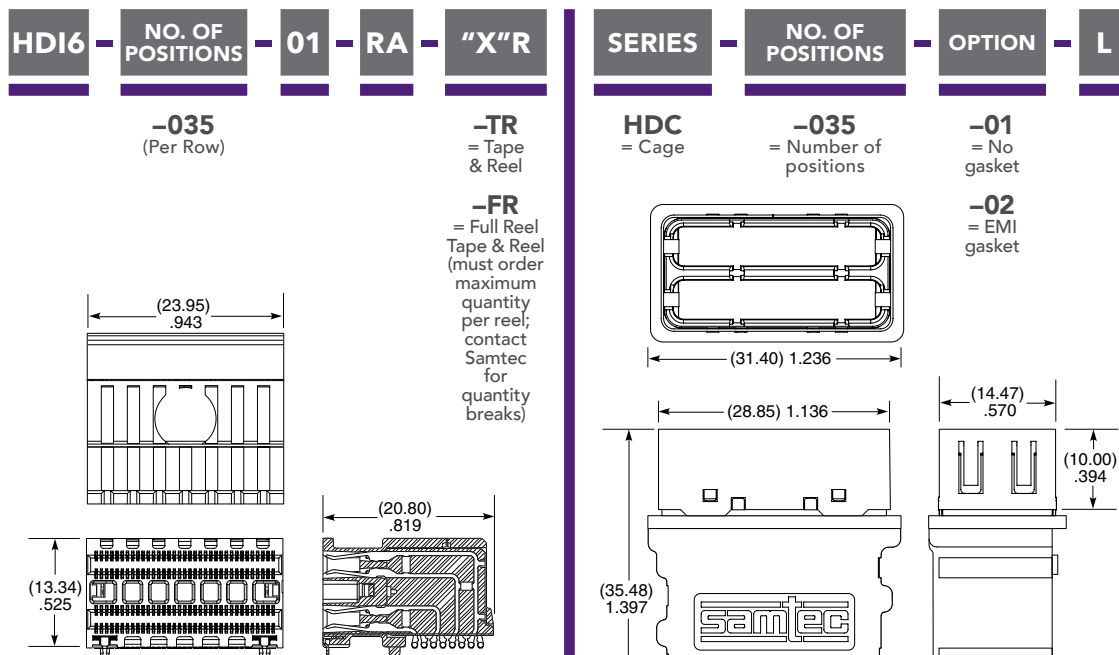
Note:
Some lengths, styles and
options are non-standard,
non-returnable.

HDLSP-035-XXX-L SHOWN
Some components not shown for clarity

HDI6 Mates: HDLSP

SPECIFICATIONS

Insulator Material:
Black LCP
Terminal Material:
Phosphor Bronze
Plating:
Au or Sn over 50 μ" (1.27 μm) Ni
Current Rating:
1.5 A per pin
(4 adjacent pins powered)
Operating Temp Range:
-25 °C to +105 °C
Voltage Rating:
150 VAC



Notes:
For HT3.1 see
www.samtec.com/ht3 and
specify part number
ASP-149117-01

Some lengths, styles and
options are non-standard,
non-returnable.

HDC-035-02-L SHOWN

Mouser Electronics

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